

ESDAXLC6-1BU2

Single-line bidirectional ESD protection for high speed interface

Datasheet - production data

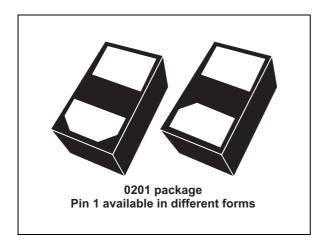
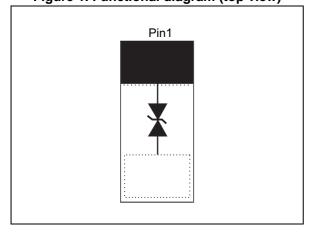


Figure 1. Functional diagram (top view)



Features

- Bidirectional device
- Extra low diode capacitance: 0.4 pF
- Low leakage current
- 0201 SMD package size compatible
- Ultra small PCB area: 0.18 mm²
- ECOPACK®2 and RoHS compliant component

Complies with the following standards:

- IEC 61000-4-2 level 4
 - ±15 kV (air discharge)
 - ±8 kV (contact discharge)

Applications

Where transient overvoltage protection in ESD sensitive equipment is required, such as:

- Smartphones, mobile phone and accessories
- Tablet PCs, netbooks and notebooks
- Portable multimedia devices and accessories
- · Digital cameras and camcorders
- · Communication and highly integrated systems

Description

The ESDAXLC6-1BU2 is a bidirectional single line TVS diode designed to protect the data lines or other I/O ports against ESD transients.

The device is ideal for applications where both reduced line capacitance and board space saving are required.

Characteristics ESDAXLC6-1BU2

1 Characteristics

Table 1. Absolute maximum ratings ($T_{amb} = 25$ °C)

Symbol	Parameter	Value	Unit
V _{PP}	Peak pulse voltage: IEC 61000-4-2 contact discharge IEC 61000-4-2 air discharge	± 16 ± 25	kV
P _{PP}	Peak pulse power (8/20 μs)	40	W
I _{PP}	Peak pulse current (8/20 μs)	1.3	Α
Tj	Operating junction temperature range	- 40 to +150	°C
T _{stg}	Storage temperature range	- 65 to +150	°C
T _L	Maximum lead temperature for soldering during 10 s	260	°C

Note: For a surge greater than the maximum values, the diode will fail in short-circuit

Figure 2. Electrical characteristics (definitions)

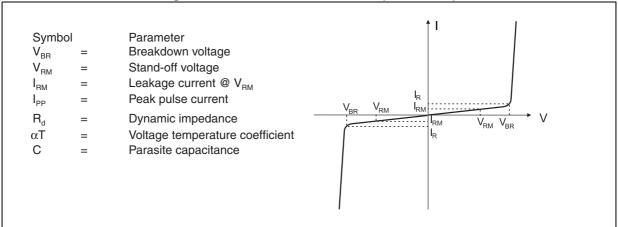


Table 2. Electrical characteristics (values, T_{amb} = 25 °C)

Symbol	Test Condition	Min.	Тур.	Max.	Unit
V_{BR}	I _R = 1 mA	6			V
I _{RM}	$V_{RM} = 3 V$			70	nA
V _{CL}	I _{PP} = 1 A, 8/20 μA			17	V
C _{line}	$F = (200 \text{ MHz} - 3000 \text{ MHz}), V_R = 0 \text{ V}$		0.4	0.5	pF

ESDAXLC6-1BU2 Characteristics

Figure 3. Leakage current versus junction temperature (typical values)

Figure 4. Junction capacitance versus applied voltage (typical values)

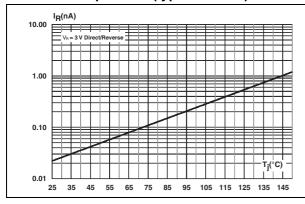
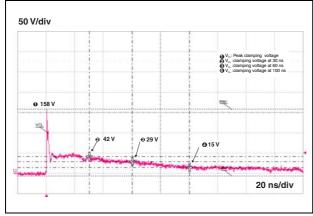


Figure 5. ESD response to IEC 61000-4-2 (+8 kV contact discharge)

Figure 6. ESD response to IEC 61000-4-2 (-8 kV contact discharge)



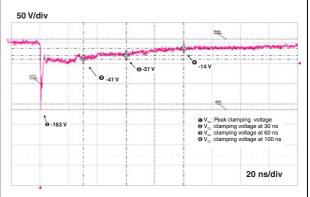
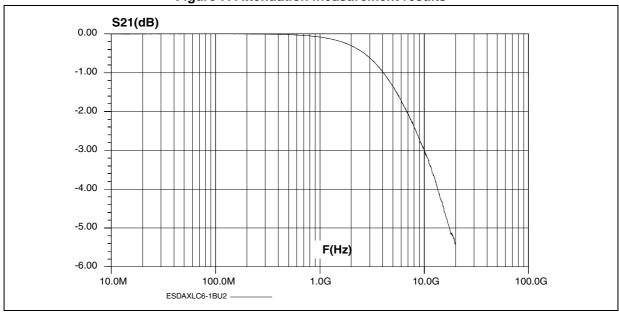


Figure 7. Attenuation measurement results



Package information ESDAXLC6-1BU2

2 Package information

- Epoxy meets UL94, V0
- Lead-free package

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: www.st.com. ECOPACK[®] is an ST trademark.

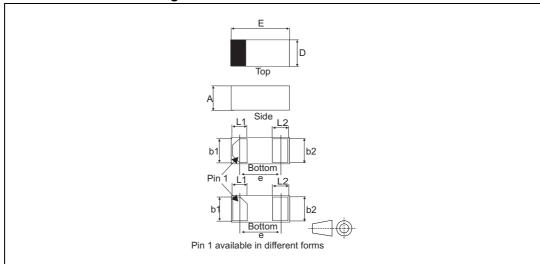


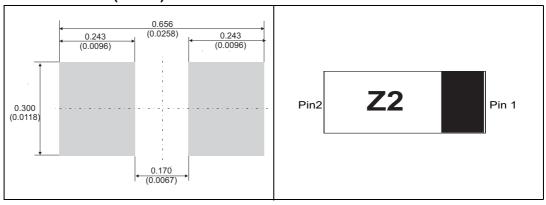
Figure 8. 0201 dimension definitions

Table 3. 0201 package dimension values

	Dimensions					
Ref.		Millimeters			Inches	
	Min.	Тур.	Max.	Min.	Тур.	Max.
Α	0.23	0.28	0.33	0.0091	0.0110	0.0130
b1	0.20	0.25	0.30	0.0079	0.0098	0.0118
b2	0.20	0.25	0.30	0.0079	0.0098	0.0118
D	0.25	0.30	0.35	0.0099	0.0118	0.0138
Е	0.55	0.60	0.65	0.0217	0.0236	0.0256
е		0.35			0.0138	
L1	0.13	0.18	0.23	0.0052	0.0071	0.0091
L2	0.14	0.19	0.24	0.0055	0.0075	0.0095

Figure 9. Footprint dimensions in mm (inches)

Figure 10. Marking



Note:

Product marking may be rotated by 180° for assembly plant differentiation. In no case should this product marking be used to orient the component for its placement on a PCB. Only pin 1 mark is to be used for this purpose.

Bar indicates Pin 1

O.22

O.34

O.38

User direction of unreeling

Figure 11. Tape and reel specifications

3 Recommendation on PCB assembly

3.1 Stencil opening design

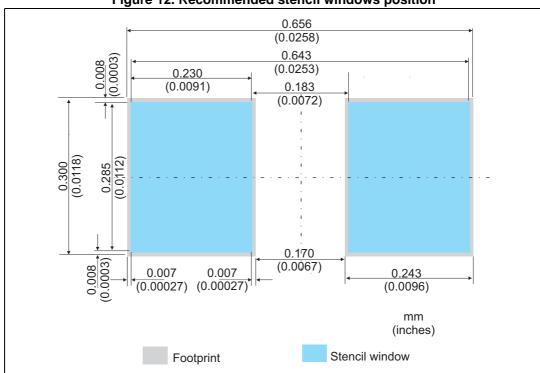


Figure 12. Recommended stencil windows position

3.2 Solder paste

- 1. Halide-free flux qualification ROL0 according to ANSI/J-STD-004.
- 2. "No clean" solder paste is recommended.
- 3. Offers a high tack force to resist component movement during high speed
- 4. Solder paste with fine particles: powder particle size is 20-45 μm .

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3.3 **Placement**

- Manual positioning is not recommended.
- 2. It is recommended to use the lead recognition capabilities of the placement system, not the outline centering
- 3. Standard tolerance of + 0.05 mm is recommended.
- 3.5 N placement force is recommended. Too much placement force can lead to squeezed out solder paste and cause solder joints to short. Too low placement force can lead to insufficient contact between package and solder paste that could cause open solder joints or badly centered packages.
- To improve the package placement accuracy, a bottom side optical control should be performed with a high resolution tool.
- For assembly, a perfect supporting of the PCB (all the more on flexible PCB) is recommended during solder paste printing, pick and place and reflow soldering by using optimized tools.

3.4 PCB design preference

- To control the solder paste amount, the closed via is recommended instead of open
- The position of tracks and open vias in the solder area should be well balanced. The symmetrical layout is recommended, in case any tilt phenomena caused by asymmetrical solder paste amount due to the solder flow away.

3.5 Reflow profile

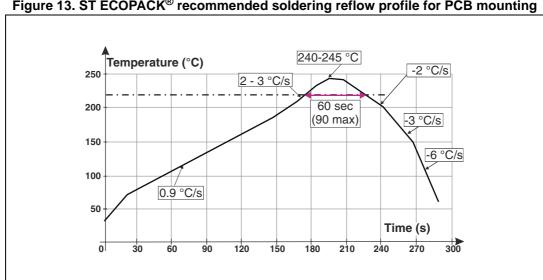


Figure 13. ST ECOPACK® recommended soldering reflow profile for PCB mounting

Note:

Minimize air convection currents in the reflow oven to avoid component movement. Maximum soldering profile corresponds to the latest IPC/JEDEC J-STD-020.

Ordering information ESDAXLC6-1BU2

4 Ordering information

Figure 14. Ordering information scheme

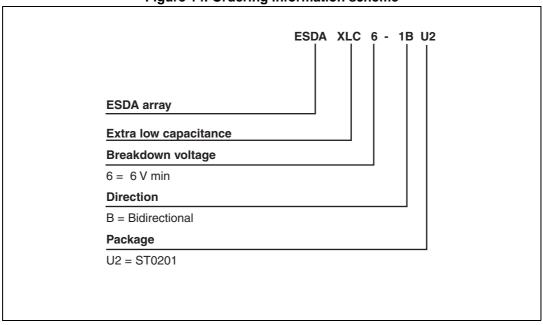


Table 4. Ordering information

Order code	Marking	Weight	Base qty	Delivery mode
ESDAXLC6-1BU2	Z2 ⁽¹⁾	0.124 mg	15000	Tape and reel

^{1.} The marking can be rotated by 180° to differentiate assembly location

5 Revision history

Table 5. Document revision history

Date	Revision	Changes
21-Sep-2012	1	Initial release.
27-Mar-2014	2	Updated Figure 5, Figure 6, Figure 7, Figure 9 and Figure 13. Updated package graphics.

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